



# Product Change Notification

**Change Notification #:** 118486-00  
**Change Title:** Select Intel® SSD D7-P5500 Series, and Intel® SSD D7-P5600 Series for Dell PE\*  
PCN 118486-00, Product Material,  
Add alternate DRAM to ADP BOM  
**Date of Publication:** September 17, 2021

## Key Characteristics of the Change:

Product Material

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material</b>	December 17, 2021
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## Description of Change to the Customer:

The Intel SKUs listed in the products affected table will have the following changes.

1. Current DRAM IPN# J87850-001 EOL-ing (Nanya) and changing to new IPN# J87850-002 (Nanya), affect ADP ME SFF 3.2T, ADP SE SFF 3.8T, ADP AICx8 6.4T.
2. Current DRAM IPN# K47704-001 EOL-ing (Samsung) and changing to new IPN# K92222-002 (Hynix), affected ADP ME 6.4T and ADP SE 7.6T

## Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers. Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

\*Other names and brands may be claimed as the property of others.

## Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	TA	SA	PBA
Intel® SSD D7-P5500 Series (3.84TB, 2.5in PCIe 4.0 x4, 3D3, TLC) Dell PE Single Pack	SSDPF2KX038T9TP	99A0ZK	K90153-100	K90179-100	K83461-103
Intel® SSD D7-P5500 Series (7.68TB, 2.5in PCIe 4.0 x4, 3D3, TLC) Dell PE Single Pack	SSDPF2KX076T9TP	99A0ZL	K90155-100	K90180-100	K83463-103
Intel® SSD D7-P5600 Series (3.2TB, 2.5in PCIe 4.0 x4, 3D3, TLC) Dell PE Single Pack	SSDPF2KE032T9TP	99A0ZN	K90157-100	K90191-100	K83461-103
Intel® SSD D7-P5600 Series (6.4TB, 2.5in PCIe 4.0 x4, 3D3, TLC) Dell PE Single Pack	SSDPF2KE064T9TP	99A0ZP	K90158-100	K90192-100	K83463-103
Intel® SSD D7-P5600 Series (6.4TB, 2.5in PCIe 4.0 x4, 3D3, TLC) Dell PE No OPAL Single Pack	SSDPF2KE064T9TO	99A2MH	K94336-100	K94343-100	K83463-103
Intel® SSD D7-P5500 Series (3.84TB, 2.5in PCIe 4.0 x4, 3D3, TLC) DELL Power Edge No OPAL Single Pack	SSDPF2KX038T9TO	99A568	K99238-100	K99253-100	K83461-103
Intel® SSD D7-P5500 Series (7.68TB, 2.5in PCIe 4.0 x4, 3D3, TLC) DELL Power Edge No OPAL Single Pack	SSDPF2KX076T9TO	99A569	K99240-100	K99255-100	K83463-103
Intel® SSD D7 P5600 Series (3.2TB, 2.5in PCIe 4.0 x4, 3D3, TLC) DELL Power Edge No OPAL Single Pack	SSDPF2KE032T9TO	99A56C	K99233-100	K99248-100	K83461-103

## PCN Revision History:

**Date of Revision:**

September 17, 2021

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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